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(12) **United States Design Patent**  
**Nguyen**

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(54) **NAIL POLISH REMOVAL PACKET**

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(\*\*) Term: **14 Years**

(21) Appl. No.: **29/421,944**

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(51) **LOC (10) Cl.** ..... **28-03**

(52) **U.S. Cl.**  
USPC ..... **D28/57**

(58) **Field of Classification Search**  
CPC ..... A45D 29/007; A45D 2200/1009;  
A45D 37/00; A45D 29/16-29/17; A45D  
2200/1018; A45D 2200/1036-2200/1045;  
A61K 8/0208  
USPC ..... 132/74.5, 320, 73; D28/56-60;  
15/209.1, 210.1, 104.94  
See application file for complete search history.

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(57) **CLAIM**

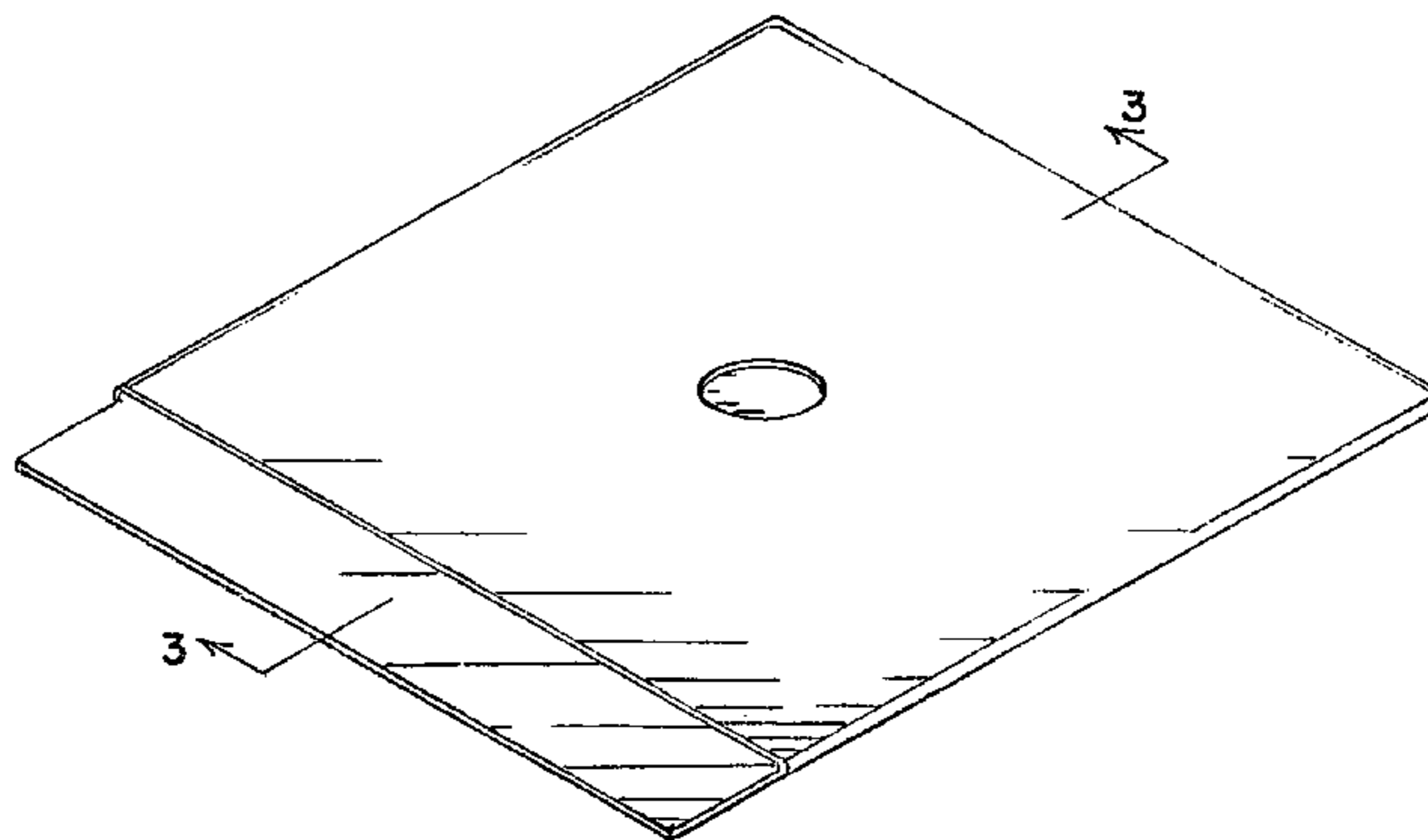
I claim the ornamental design for a nail polish removal packet, substantially as shown and described.

**DESCRIPTION**

Attention is drawn to a concurrently filed, subject matter related utility application, Ser. No. 13/694,081, of Tinh Nguyen, entitled Nail Polish Removal Method and Device, the entire disclosure of which is incorporated herein by reference.

FIG. 1 is a perspective view of a nail polish removal packet, showing front, top and right side portions of my new design; FIG. 2 is a right side view thereof, it being understood that a left side view is a mirror image reversal hereof; FIG. 3 is a cross-sectional view as seen from a plane indicated by a line indicated by the numbers 3-3 in FIG. 1; FIG. 4 is a rear view thereof; FIG. 5 is a front view thereof; FIG. 6 is a top view thereof; and, FIG. 7 is a bottom view thereof.

**1 Claim, 2 Drawing Sheets**



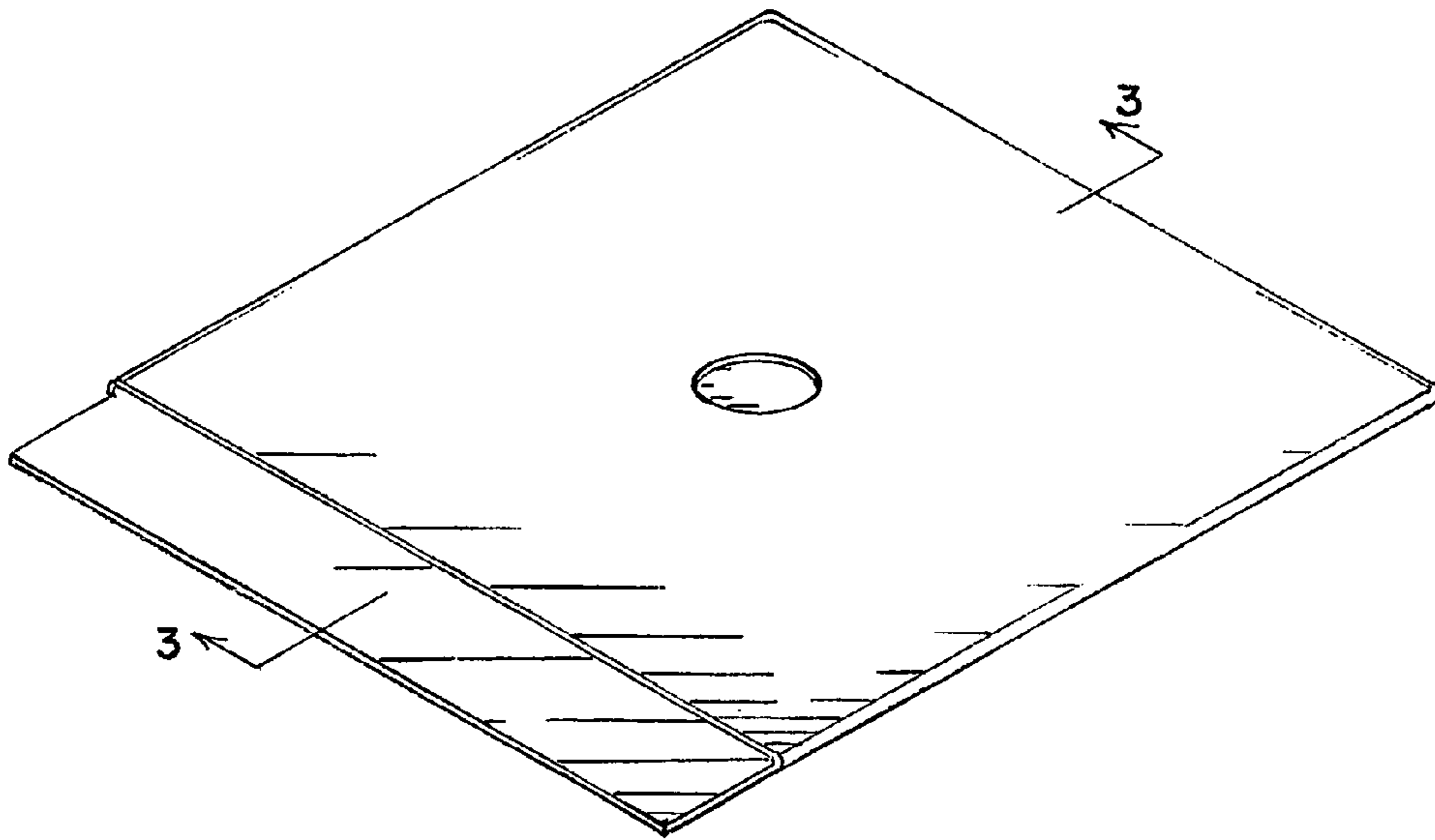


FIG. 1

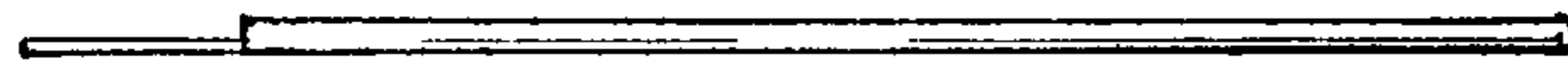


FIG. 2



FIG. 3

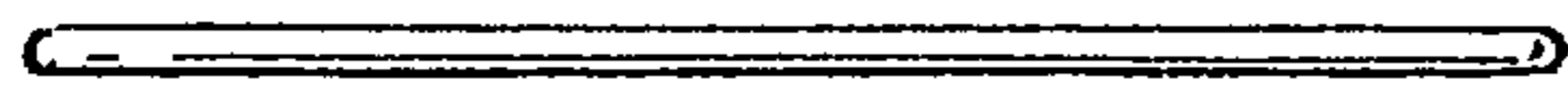


FIG. 4

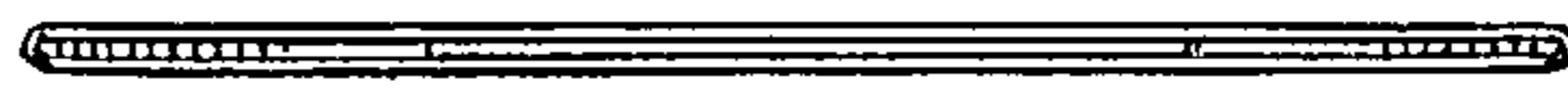


FIG. 5

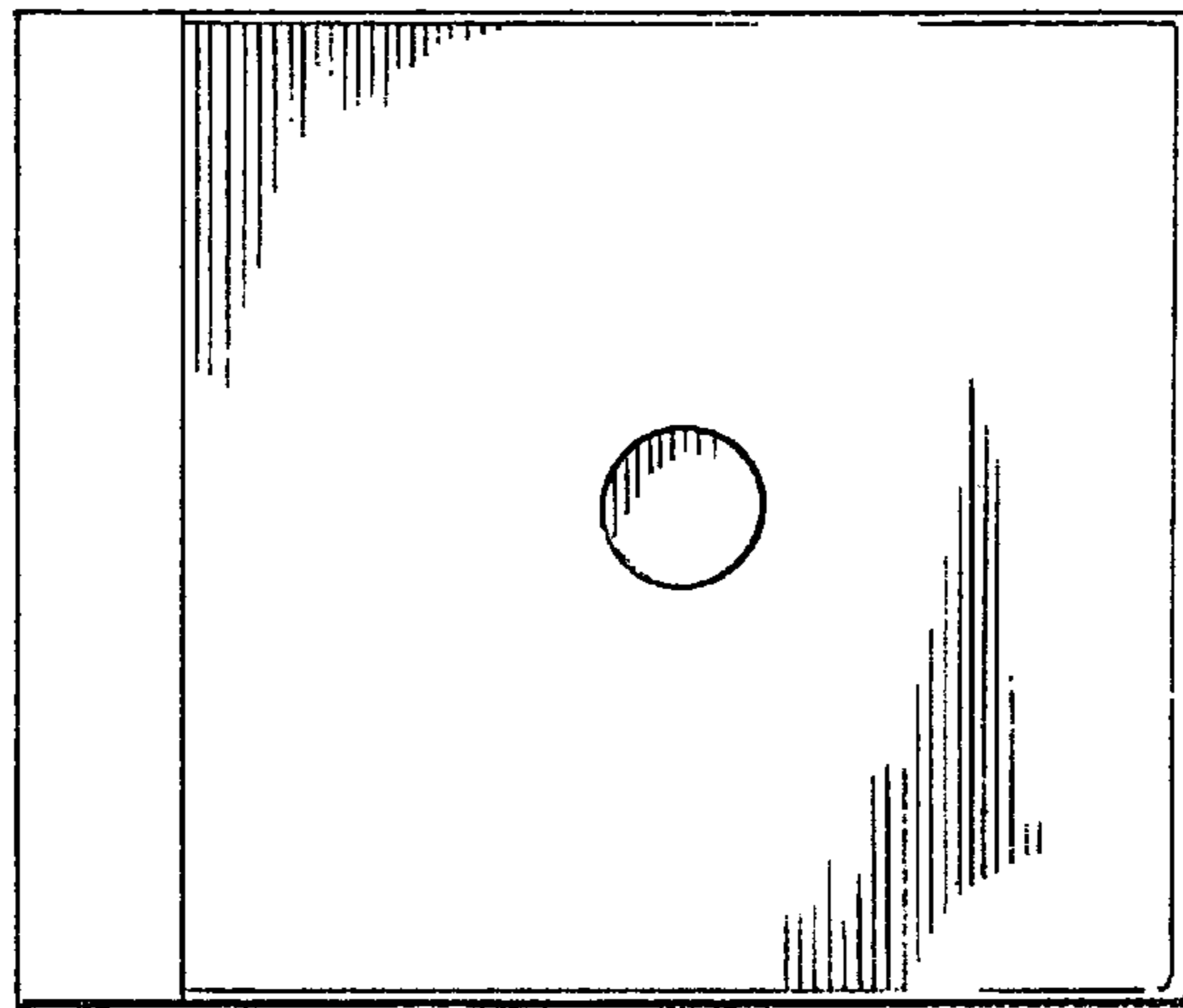


FIG. 6

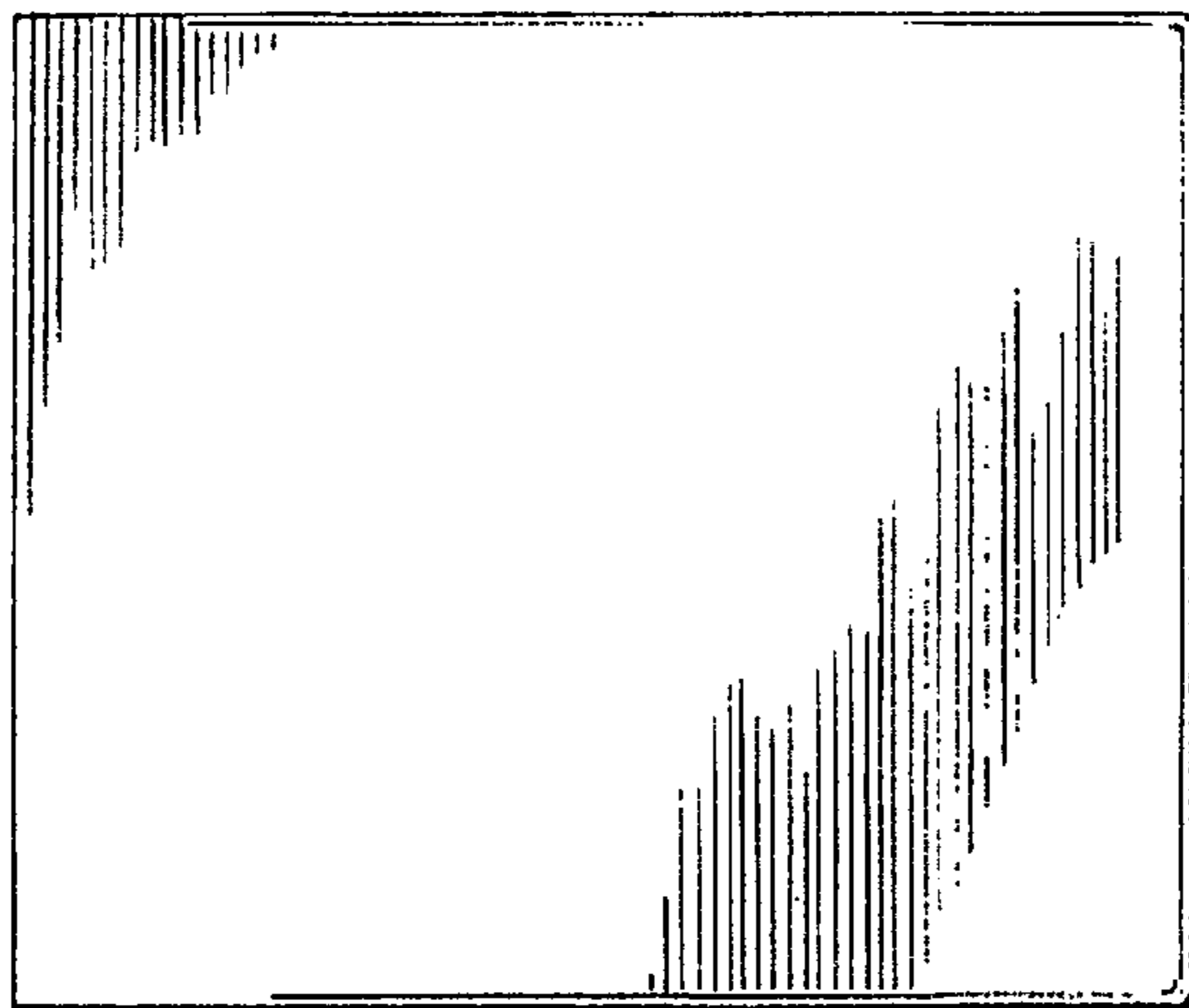


FIG. 7